

Reissue of U.S. Patent No. 6,329,213 B1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Practitioner's Docket No. MI40-369

This is part of the application for a reissue patent filed herewith based on the original patent identified as follows:

Inventors: Mark E. Tuttle et al.

Patent Number: 6,329,213 B1

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Title of Invention: Methods for Forming Integrated Circuits within Substrates

To: Mail Stop Reissue
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AMENDMENT UNDER 37 C.F.R. §1.173(b)